REVISIONS

REV.	Description	Date	Approvaled by	Checked by	Checked by	Prepared by
00	Preliminary release		Alfa	Vincent	Vivian	Menghua
<u> </u>						



I. SCOPE:

This specification applies to the Pb Free high current type SMD inductors for MMD-10DZ-SERIES \Box

PRODUCT INDENTIFICATION

- ① ② ③ ④ ⑤
 - ① Product Code
 - ② Dimensions Code
 - 3 Inductance Code
 - 4 Tolerance Code
 - ⑤ Inner Control Code

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INDER		
LISTED ITEM	ATTACHEMENT & TABLES	PAGE
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6. LAND DIMENSION (Ref.)	Please see (5)	7/9
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8. STANDARD TEST CONDITIONS

Unless otherwise specified, test condition should be Temp. =20±5°C,

Humidity= $35\sim85\%$

But if needed, then test condition should be Temp. $=20\pm2$ °C,

Humidity=65±5%

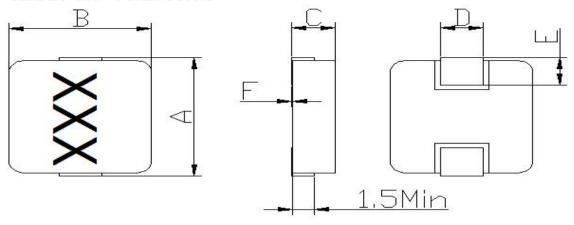
9. SHELF LIFE

Storage Condition:The temperature should be within-40°C ~105°C and humidity should be less than 75%RH. The product should be used within 12 months from the time of delivery.

In addition, suggest to use product within 6 months from the time of delivery.



(1) SHAPES AND DIMENSIONS



A: 11.2±0.3

mm

E: 2.0±0.5

mm

B: 10.2±0.3

mm

C: 4.0Max. D: 3.0 ref

m

(2) ELECTRICAL SPECIFICATIONS

SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

(3)-1 Operate temperature range $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ (Including self temp. rise)

(3)-2 Storage temperature range $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$

MATERIALS

NO.	ITEM	DESCRIPTION & TYPE	UL NO.	MANUFACTURER
1	CORE	FERRITE		JIANGXI YUEAN
2	WIRE	POLYURETHANE ENAMELLED	E258243	ELEKTRISOLA CO., LTD.
		COPPER WIRE	E84081	PACIFIC ELECTRICAL WIRE & CABLE CO., LTD.
3	SOLDER	Sn99. 3%/Cu0. 7%		SOLENT METAL INDUSTRY CO., LTD.
				DONGGUAN ZHONGSHUN



TABLE 1

MAGLAYERS	Inductance	Percent	L Test	Resistance	Poted N	Current
PT/NO.	L(µH)	Tolerance	Frequency	RDC(mΩ)MAX	Idc(A)	Isat(A)
MMD-10DZ-R22□□- □□	0. 22	M, N	100KHz/0.25V	1.80	30.000	50.000
MMD-10DZ-R36□□- □□	0.36	M, N	100KHz/0.25V	2.10	28. 000	45.000
MMD-10DZ-R68□□- □□	0.68	M, N	100KHz/0.25V	2. 70	21.000	30.000
MMD-10DZ-1R0□□- □□	1.00	M, N	100KHz/0.25V	4.50	18.000	25. 000
MMD-10DZ-1R2□□- □□	1.20	M, N	100KHz/0.25V	5. 00	15. 000	23. 000
MMD-10DZ-2R2□□- □□	2. 20	M, N	100KHz/0.25V	8. 00	12. 000	18.000
MMD-10DZ-2R7□□- □□	2. 70	M, N	100KHz/0.24V	10.00	11.000	16.000
MMD-10DZ-3R3□□- □□	3. 30	M, N	100KHz/0.25V	12. 00	11.000	16.000
MMD-10DZ-4R7□□- □□	4. 70	M, N	100KHz/0.25V	18. 00	9. 000	14.000
MMD-10DZ-5R6□□- □□	5. 60	M, N	100KHz/0.25V	22. 00	7. 000	12.000
MMD-10DZ-8R2□□- □□	8. 20	M, N	100KHz/0.26V	30.00	5. 500	8. 000
MMD-10DZ-220□□- □□	22. 00	M, N	100KHz/0.25V	80.00	4.500	7. 000
MMD-10DZ-330□□- □□	33. 00	M, N	100KHz/0.25V	91.00	4. 440	5. 050
MMD-10DZ-470□□- □□	47.00	M, N	100KHz/0.25V	155. 00	1.500	2. 500

 $\mbox{\em M}$ $\mbox{\em \Box}$ specify the inductance tolerance , M(±20%) , N(±30%)

% Isat: Based on inductance change (\triangle L/Lo: drop 30% Max.) @ ambient temp. 25°C

Idc: Based on temperature rise ($\triangle T$: 40°C Typ.)



(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Substrate bending	△L/Lo≦±5%	The sample shall be soldered onto the printed circuit board
		in figure 1 and a load applied unitil the figure in the arrow
	There shall be	direction is made approximately 3mm. (keep time 30 seconds)
	no mechanical	PCB dimension shall the page 7/9
	damage or elec-	F(Pressurization)
	trical damege.	\Box
		R5 45±2 45±2 10 20
		PRESSURE ROD figure-1
Vibration	△L/Lo≦±5%	The sample shall be soldered onto the printed circuit board
		and when a vibration having an amplitude of 1.52mm
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should
	no mechanical	be applied to the 3 directions (X, Y, Z) for 2 hours each.
	damage.	(A total of 6 hours)
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated
	More than 90%	over the whole of the sample before hard, the sample shall
		then be preheated for about 2 minutes in a temperature of
		130∼150°C and after it has been immersed to a depth 0.5mm
		below for 3±0.2 seconds fully in molten solder M705 with
		a temperature of 245±5°C.
		More than 90% of the electrode sections shall be couered
		with new solder smoothly when the sample is taken out of the solder bath.



MECHANICAL

TEST ITEM		SPECIFICATION be Temperature profile of reflow soldering				
Resistance to	There shall be					
Soldering heat	no damage or					
(reflow soldering)	problems.	The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.				

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than 1 \times 10 ⁸ Ω .
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
wi thstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	△L/L20°C ≤±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85°C, and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≤±10%.



 ${\tt Contents}$

ENVIROMENT CHARACTERISTICS

TEST ITEM				SPECIFICATI	ON		
High temperature	△L/Lo≦±5%	The sampl	The sample shall be left for 96±4 hours in an atmospere with				
storage		a tempera	a temperature of 125°C and a normal humidity.				
	There shall be	Upon comp	oleti	on of the measurement	t shall be made after	r the	
	no mechanical	sample ha	as be	een left in a normal	temperature and norm	al	
	damage.	humidity	humidity for 1 hour.				
Low temperature	△L/Lo≦±5%	The sampl	le sh	nall be left for 96±4	hours in an atmosphe	ere with	
storage		a tempera	ature	e of -25±3℃.			
	There shall be	Upon comp	oleti	on of the test, the	measurement shall be	made	
	no mechanical	after the	e san	nple has been left in	a normal temperature	e and	
	damage.	normal hu	ımidi	ty for 1 hour.			
Change of	△L/Lo≦±5%	The sampl	The sample shall be subject to 5 continuos cycles, such as shown				
temperature		in the ta	able	2 below and then it	shall be subjected to	o standard	
	There shall be	atmospheric conditions for 1 hour, after which measurement					
	no other dama-	shall be made.					
	ge of problems						
			table 2				
				Temperature	Duration		
			1	−25±3°C	30 min.		
				(Themostat No.1)			
			2	Standard	No. 1→No. 2		
				atmospheric	NO. 1 - NO. 2		
			3	85±2℃	30 min.		
				(Themostat No. 2)			
			4	Standard	No. 2→No. 1		
				atmospheric]	
Moisture storage	△L/Lo≦±5%	The sampl	le sh	nall be left for 96±4	hours in a temperate	ure of	
		40±2℃ ar	nd a	humidity(RH) of 90~9	95%.		
	There shall be			on of the test, the m		made	
	no mechanical	after the sample has been left in a normal temperature and				e and	
	damage.	normal hu	midi	ty more than 1 hour.			
Test conditions:	1						
					uit board in every t		



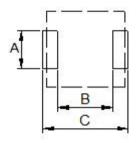
(5) LAND DIMENSION (Ref.)

PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

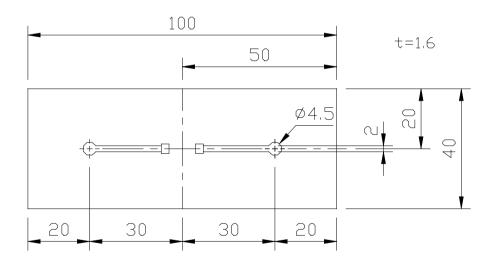
(STANDARD PATTERN)

unit: mm



A	В	С
4.1	5. 4	13. 5

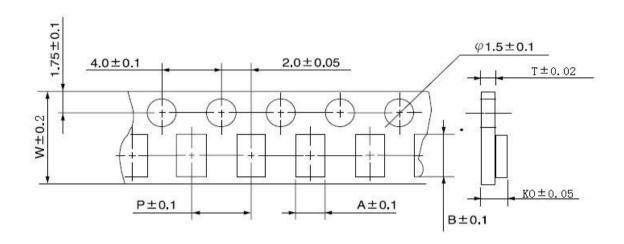
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



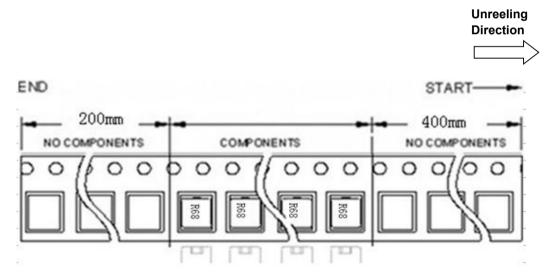


(6) PACKAGING

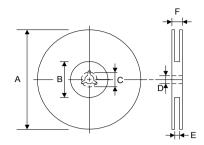
(6)-1 CARRIER TAPE DIMENSIONS (mm)

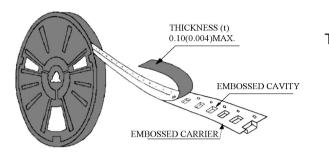


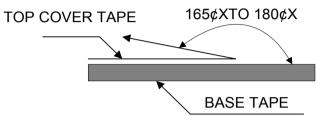
(6)-2 TAPING DIMENSIONS (mm)



(6)-3 REEL DIMENSIONS (mm)







(6)-4 QUANTITY

500 pcs/Reel

The products are packaged so that no damage will be sustained.

